

ATIS Series

Fanless Industrial PC with Rich I/O for Edge Computing & Data Collection Solutions



Modular



Fanless



Scalability



Minimal Investment



Rugged & Durable



Expandable Slot Configuration



Energy Efficient



Intel Atom Triple-Gen Support

- ATIS-S1201: E3900 Series Processors
- ATIS-S200A: x6000E Series Processors
- ATIS-S1601: x7000RE Series Processors

Amston Lake



ATIS-S1601

Elkhart Lake



ATIS-S200A

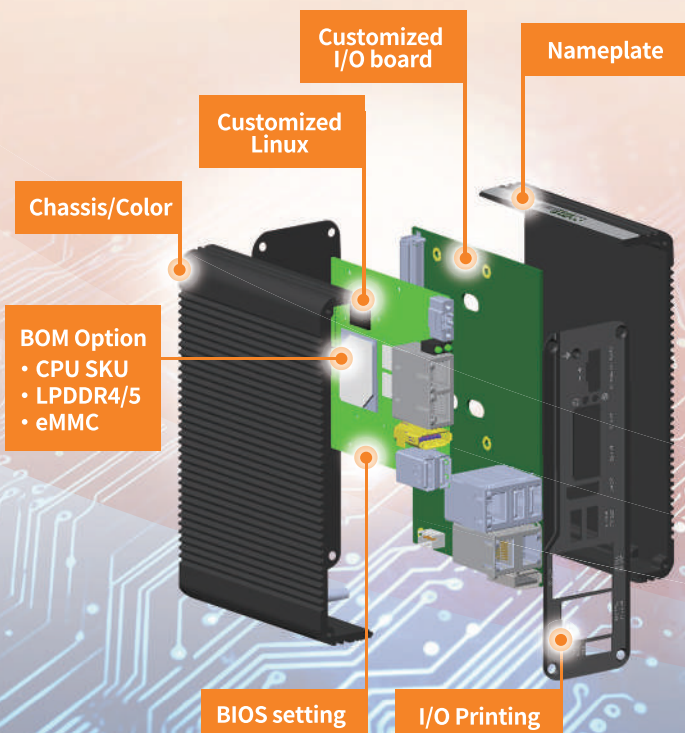
Apollo Lake



ATIS-S1201

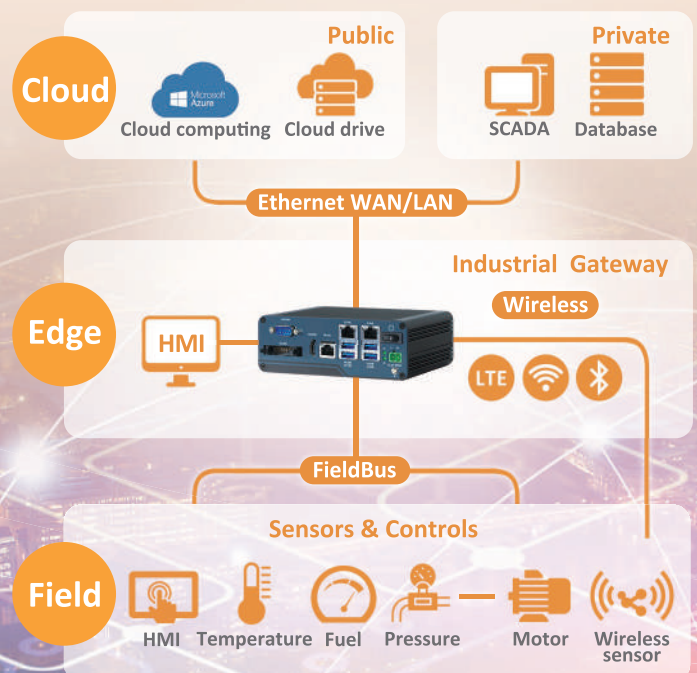
SMARC Module with Flexibility I/O

Empowering tailored applications with SMARC modules and customized carriers for various environments.



Edge Computing Advantage

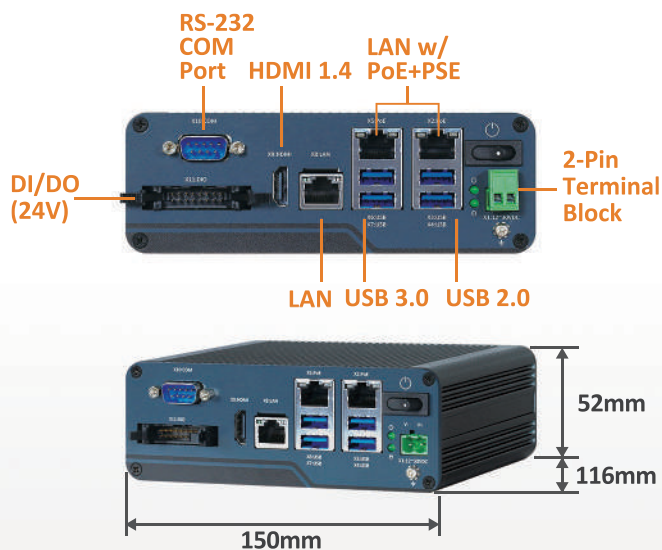
- Low Latency – Faster real-time processing.
- Bandwidth Efficiency – Reduces cloud dependency.
- Enhanced Security – Keeps data local.



Advanced Tiny Industrial System

Fanless Design Industrial Embedded BOX PC

Intel Atom® Amston Lake



ATIS-S1301 / ATIS-S1601

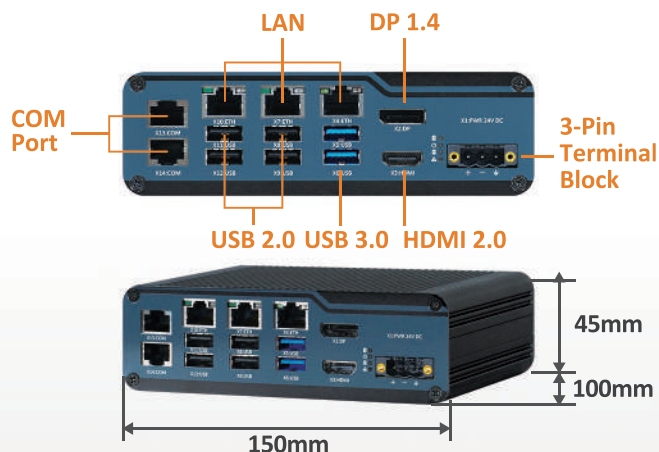
- CPU:
 - Entry: Intel Atom E3940 Apollo Lake Processor
 - High-End: Intel Atom x7433RE Amston Lake Processor
- Operating Temperature: -20°C ~ 50°C
- EMC Standard: CE, FCC

Features

It is equipped with POE functionality, allowing connected devices to receive power through the network, enhancing wiring setup efficiency

ATIS-S1301	Intel® Atom E3940, 4 cores, 1.6GHz/1.8 GHz, 9.5W TDP	LPDDR4 up to 8GB	eMMC 5.0 on board 32GB	Expansion: 1x M.2 M Key 2242 SATA SSD 128GB (option)
ATIS-S1601	Intel® Atom x7433R, 4 cores, 3.4 GHz, 9W TDP	LPDDR5 up to 8GB	eMMC 5.1 on board 64GB	

Intel Atom® Elkhart Lake



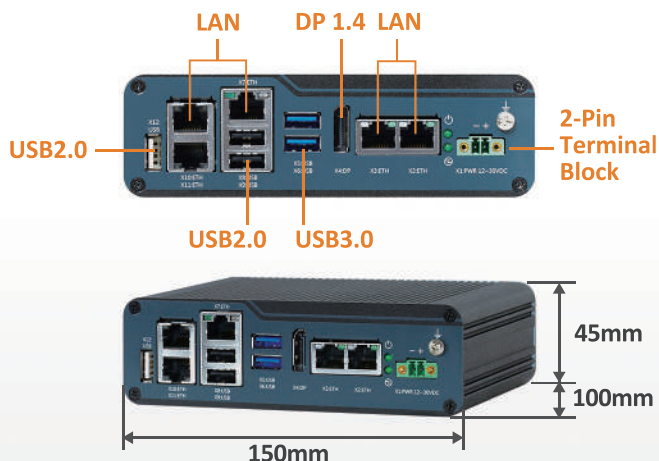
ATIS-S200A

- CPU: Intel Atom x6211E/x6413E/ x6425E Elkhart Lake Processor
- Memory: DDR4 SO-DIMM 8GB
- Storage M.2 Key B 2242 (SATA or PCIe) up to 128GB
- Operating Temperature: -20°C ~ 50°C
- EMC Standard: CE, FCC

Features

It offers expandable options for SIM, Wi-Fi, and M.2 SSD, along with rich I/O interface (3x LAN, 6x USB, 1x DP, 1x HDMI, 2x RJ45 COM port) for Versatile Device Compatibility

Intel Atom® Apollo Lake



ATIS-S1201

- CPU: Intel Celeron N3350 Apollo Lake Processor
- Memory: On Board LPDDR4 4GB
- Storage: eMMC 5.0 on board 64GB
- Operating Temperature: -20°C ~ 50°C
- EMC Standard: CE, FCC

Features

The Compact Design for Space-Constrained Applications, Intel Celeron N3350 Processor for Stable and Low-Power Consumption. It offers a variety of I/O interfaces (5x LAN, 5x USB, 1x DP) to provide flexible connectivity options



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